74LVTH245 3.3V, Octal Transceiver with Direction Pin and 3-State Outputs

GENERAL DESCRIPTION

The 74LVTH245 device is a high-performance 8-bit transceiver for 3.3V V_{CC} operation, but with the capability to provide an interface to 5V system environment. The non-inverting 3-state bus compatible outputs are available in both sending and receiving directions.

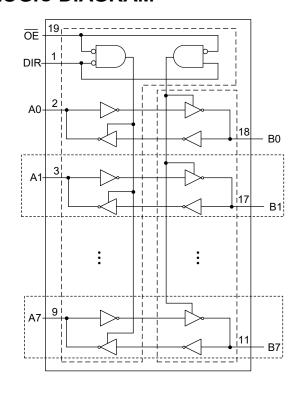
The device can be used as an 8-bit transceiver. The direction control (DIR) input determines the direction of the data flow. DIR (active high) enables data from An port to Bn port. DIR (active low) enables data from Bn port to An port. The output enable (\overline{OE}) input, when high, disables both An and Bn ports by placing them in a high-impedance state.

The 74LVTH245 bus hold-on data inputs eliminate the need for external pull-up/pull-down resistors to hold unused inputs.

FEATURES

- Wide Operating Voltage Range: 2.7V to 3.6V
- Input and Output Interface Capability to 5V System Environment
- +64mA/-32mA Output Current
- 3-State Outputs Drive Bus Lines Directly
- Power-up and I_{OFF} 3-State
- Bus Hold-on Data Inputs with No Need for External Pull-up/Pull-down Resistors
- -40℃ to +125℃ Operating Temperature Range
- Available in a Green TQFN-4.5×2.5-20L Package

LOGIC DIAGRAM



FUNCTION TABLE

CONTRO	L INPUT	INPUT/OUTPUT			
ŌĒ	DIR	An	Bn		
L	L	An = Bn	Inputs		
L	Н	Inputs	Bn = An		
Н	X	Z	Z		

H = High Voltage Level

L = Low Voltage Level

Z = High-Impedance State

X = Don't Care

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
74LVTH245	TQFN-4.5×2.5-20L	-40°C to +125°C	74LVTH245XTRH20G/TR	R5CRH XXXXX	Tape and Reel, 6000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS (1)

ADSOLUTE INIAXIINIONI KATIIN	G G
Supply Voltage, V _{CC}	0.5V to 4.6V
Input Voltage, V _I (2)	0.5V to 7V
Output Voltage, V _O ⁽²⁾	
Output in 3-State or High-State	0.5V to 7V
Input Clamping Current, $I_{IK}(V_I < 0V)$	50mA
Output Clamping Current, I _{OK} (V _O < 0V)	50mA
Output Current, Io	
Output in High-State	64mA
Output in Low-State	128mA
Supply Current, I _{CC}	128mA
Ground Current, I _{GND}	256mA
Junction Temperature (3)	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	V0008
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage, V _{CC}	2.7V to 3.6V
Input Voltage, V _I	0V to 5.5V
High-Level Output Current, IOH	32mA
Low-Level Output Current, IOL	64mA
Input Transition Rise and Fall Rate, Δt/ΔV	
	10ns/V (MAX)
Operating Temperature Range	40°C to +125°C

OVERSTRESS CAUTION

- 1. Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
- 2. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
- 3. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

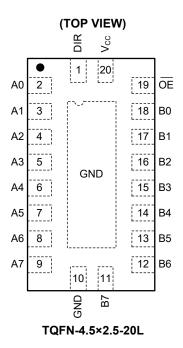
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	FUNCTION
1	DIR	Direction Control.
2, 3, 4, 5, 6, 7, 8, 9	A0, A1, A2, A3, A4, A5, A6, A7	Data Inputs/Outputs.
10	GND	Ground.
18, 17, 16, 15, 14, 13, 12, 11	B0, B1, B2, B3, B4, B5, B6, B7	Data Inputs/Outputs.
19	ŌĒ	Output Enable Input (Active Low).
20	V _{CC}	Supply Voltage.

ELECTRICAL CHARACTERISTICS

(Full = -40°C to +125°C, all typical values are measured at V_{CC} = 3.3V and T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		TEMP	MIN	TYP	MAX	UNITS	
Input Clamping Voltage	V _{IK}	V _{CC} = 2.7V, I _{IK} = -18m	ıA	Full	-1.2	-0.78		V	
High-Level Input Voltage	V _{IH}	V _{CC} = 2.7V to 3.6V		Full	2.0			V	
Low-Level Input Voltage	V _{IL}	V _{CC} = 2.7V to 3.6V		Full			0.8	V	
High-Level Output Voltage		V_{CC} = 2.7V to 3.6V, I_{C}	_{он} = -100µА	Full	V _{CC} - 0.05	V _{CC} - 0.001			
	V _{OH}	V _{CC} = 2.7V, I _{OH} = -8m.	A	Full	2.45	2.60		V	
		V _{CC} = 3.0V, I _{OH} = -32r	mA	Full	2.10	2.65			
		V - 2.7V	I _{OL} = 100μA	Full		0.001	0.05		
		$V_{CC} = 2.7V$	I _{OL} = 24mA	Full		0.15	0.28		
Low-Level Output Voltage	V _{OL}		I _{OL} = 16mA	Full		0.1	0.18	V	
		V _{CC} = 3.0V	I _{OL} = 32mA	Full		0.2	0.36		
			I _{OL} = 64mA	Full		0.4	0.55		
		Control pins, $V_{CC} = 3.6V$, $V_I = V_{CC}$ or GND		Full		±0.01	±1		
	l _l	Control pins, V _{CC} = 0V or 3.6V, V _I = 5.5V		Full		0.01	5	μΑ	
Input Leakage Current		Input/output data pins $^{(1)}$, $V_{CC} = 3.6V$, $V_{I} = 5.5V$		Full		1.4	5		
		Input/output data pins $^{(1)}$, $V_{CC} = 3.6V$, $V_{I} = V_{CC}$		Full		0.3	2		
		Input/output data pins (1), V _{CC} = 3.6V, V _I = 0V		Full	-2	-0.01			
Output Leakage Current	I _{LO}	Output in high-state v $V_0 = 5.5V$, $V_{CC} = 3.0V$	vhen V _O > V _{CC} , /	Full		1	30	μA	
Power-up/down Output Current	I _{O_PU/PD}	$V_{CC} \le 1.2V$, $V_{O} = 0.5V$ $V_{I} = GND \text{ or } V_{CC}, \overline{OE}$		+25°C		50	100	μA	
Power-off Leakage Current	I _{OFF}	$V_{CC} = 0V$, V_I or $V_O = 0$)V to 5.5V	Full		0.01	10	μA	
		V _{CC} = 3.6V.	Output high	Full		15	90		
Supply Current	I _{CC}	$V_I = GND \text{ or } V_{CC}$	Output low	Full		15	90	μA	
		I _O = 0A	Outputs disabled (2)	Full		14	85	7	
Additional Supply Current	Δl _{cc}	Per input pin, $V_{CC} = 3.0$ $V_{CC} - 0.6V$, other inputs	OV to 3.6V, one input at sat V _{CC} or GND	Full		0.2	200	μA	
Input Capacitance	Cı	DIR and \overline{OE} inputs, V _i = 0V or 3.0V		+25°C		6		pF	
Input/Output Capacitance	C _{I/O}	At input/output data nine outputs disabled		+25°C		9		pF	
Bus Hold Low Current	I _{BHL}	V _{CC} = 3.0V, V _I = 0.8V		Full	50	100		μΑ	
Bus Hold High Current	I _{BHH}	$V_{CC} = 3.0V, V_{I} = 2.0V$		Full		-130	-75	μA	
Bus Hold Low Overdrive Current (3)	I _{BHLO}	Input data pins, V _{CC} =	3.6V, V _I = 0V to 3.6V	Full	500	200		μA	
Bus Hold High Overdrive Current (3)	I _{BHHO}	Input data pins, V _{CC} =	3.6V, V _I = 0V to 3.6V	Full		-280	-500	μΑ	

NOTES:

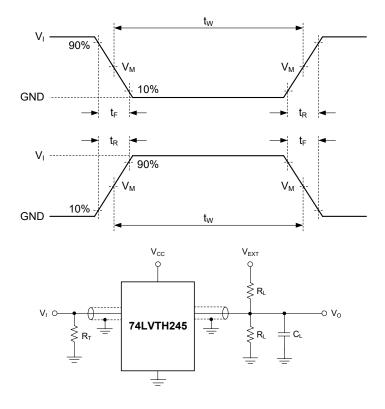
- 1. Other pins must be tied to V_{CC} or GND and should not be floating.
- 2. I_{CC} is measured with outputs pulled to V_{CC} or GND.
- 3. It is the minimum overdrive current required to switch the input from one state to another.

DYNAMIC CHARACTERISTICS

(For test circuit, see Figure 1. All typical values are measured at $V_{CC} = 3.3V$ and $T_A = +25^{\circ}C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDI	TIONS	TEMP	MIN	TYP	MAX	UNITS	
Low to High Propagation Delay	+	An to Bn or Bn to An,	V _{CC} = 2.7V	+25°C		4.3		ns	
Low to High Propagation Delay	t _{PLH}	see Figure 2	V _{CC} = 3.0V to 3.6V	+25°C		4.3		115	
High to Law Propagation Poley	+	An to Bn or Bn to An,	V _{CC} = 2.7V	+25°C		3.9		20	
High to Low Propagation Delay	t _{PHL}	see Figure 2	V _{CC} = 3.0V to 3.6V	+25°C		3.7		ns	
Off-State to High Propagation Delay	t _{PZH} \overline{OE} to An or Bn, see Figure 3	OE to An or Bn,	V _{CC} = 2.7V	+25°C		5.3		ns	
Oil-State to High Propagation Delay		see Figure 3	V _{CC} = 3.0V to 3.6V	+25°C		4.9		115	
Off State to Law Propagation Polov	4	OE to An or Bn,	V _{CC} = 2.7V	+25°C		5.0		20	
Off-State to Low Propagation Delay	t _{PZL}	see Figure 3	V _{CC} = 3.0V to 3.6V	+25°C		4.9		ns	
High to Off State Propagation Delay	+	OE to An or Bn,	V _{CC} = 2.7V	+25°C		4.9		no	
High to Off-State Propagation Delay t _P	t _{PHZ}	see Figure 3	V _{CC} = 3.0V to 3.6V	+25°C		4.6		ns	
Low to Off State Prepagation Polev	4	OE to An or Bn,	V _{CC} = 2.7V	+25°C		5.4		no	
Low to Off-State Propagation Delay	t_{PLZ}	see Figure 3	V _{CC} = 3.0V to 3.6V	+25°C		5.4		ns	

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

R_L: Load resistance.

C_L: Load capacitance (includes jig and probe).

 R_T : Termination resistance (equals to output impedance Z_O of the pulse generator).

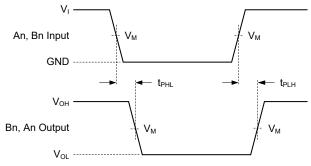
 V_{EXT} : External voltage used to measure switching time.

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

SUPPLY VOLTAGE	IN	PUT	LO	AD	V _{EXT}		
V _{CC}	Vı	t _R , t _F	CL	R _L	t _{PHZ} , t _{PZH}	t _{PHZ} , t _{PZH} t _{PLZ} , t _{PZL}	
2.7V to 3.6V	2.7V	≤ 2.5ns	50pF	500Ω	GND	6V	Open

WAVEFORMS

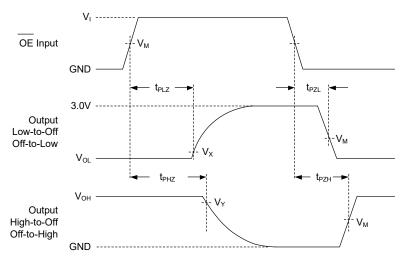


Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 2. Input (An, Bn) to Output (Bn, An) Propagation Delays



Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 3. Enable and Disable Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INF	PUT	OUTPUT			
V _{cc}	Vi	V _M ⁽¹⁾	V _M	V _X	V _Y	
2.7V to 3.6V	2.7V	1.5V	1.5V	V _{OL} + 0.3V	V _{OH} - 0.3V	

NOTE: 1. The measurement points should be V_{IH} or V_{IL} when the input rising or falling time exceeds 2.5ns.

3.3V, Octal Transceiver with Direction Pin and 3-State Outputs

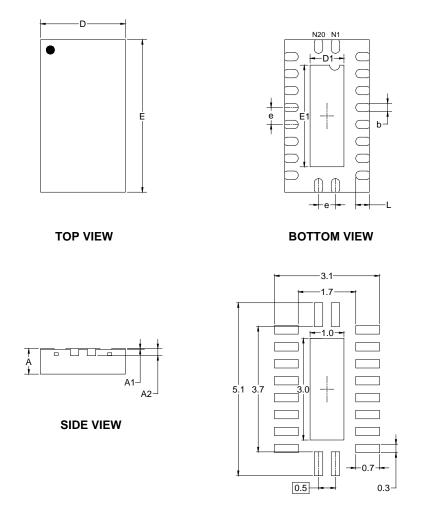
74LVTH245

REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JANUARY 2022 – REV.A to REV.A.1	Page
Updated I _I and I _{CC} values in Electrical Characteristics section	4
Changes from Original (MARCH 2021) to REV.A	Page
Changed from product preview to production data	All

PACKAGE OUTLINE DIMENSIONS TQFN-4.5×2.5-20L



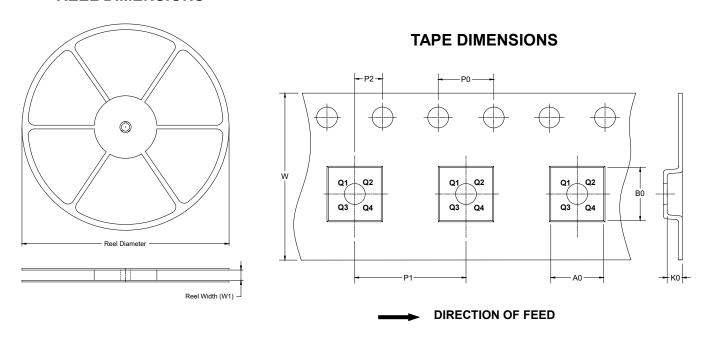
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters						
Symbol	MIN	MOD	MAX				
Α	0.70	0.75	0.80				
A1	0.00	0.02	0.05				
A2		0.203 REF					
b	0.20	0.25	0.30				
D	2.40	2.50	2.60				
D1	0.85	1.00	1.15				
E	E 4.40 4.50		4.60				
E1	2.85	3.00	3.15				
е	0.45	0.50	0.55				
L	0.30	0.40	0.50				

NOTE: This drawing is subject to change without notice.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



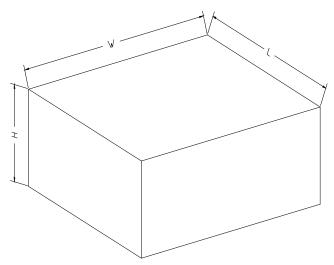
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TQFN-4.5×2.5-20L	13"	12.4	2.75	4.75	1.00	4.0	8.0	2.0	12.0	Q1

DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13″	386	280	370	5